			1.1	-08-2000		
×	Patents Trade narks	To the Honora Please record			es: of.	
1.	Name of Party(ies) con	veying an interest:	10	1510030	? Party(ies) receiving an interes	t:
Procom Technology, Inc.			Name: The CIT Group/Business Credit, Inc. Internal Address: Street Address: 300 South Grand Avenue, Third Floor			
		1 1 - 18	- 60	City: Los Angeles	Zip: <u>900</u>	
-	Entity (e.g. Procom Tec ☐ Individual(s) ☐ General Partnership ☒ Corporation-State: ☐ Other	Association Limited Parti California		☐ Individual(s) ☐ General Partn ☑ Corporation-S ☐ Other Citizenship	Group/Business Credit, Inc.): Association ership Limited Partnersh State: New York ed in the United States, a domestic edesignation is attached:	
3.	Interest Conveyed: ☐ Assignment ☑ Security Agreement ☐ Other Execution Date: As of		nership			
4. Application number(s), patent numbers, or registration number(s). Additional sheet attached: Patent No. 5077683						Yes No
5.	A AND A CONTRACTOR OF THE PARTY			6. Number of applications, patents, or registrations involved:		
Nan				7. Amount of fee end	closed or authorized to be charged	 :
Internal Address: Ms. Penelope Agodoa Street Address: 400 Seventh Street, N.W., Suite 101 City: Washington				\$40.00		
Stat	e: District of Columbia	Zip	:_20004	8. Deposit account n form if paying by	umber (Attach duplicate copy of ti deposit account):	his
	00 DBYRNE 00000084 5077				-	
C:581		40.00 OP	OO NOT USE	THIS SPACE		
9.	Date of execution of att	ached document As of	October 10, 2	000		
10. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original documents.						
	October 16, 2000					
Date Paul Toland						
	Signature			Name of Person Signing		

GRANT OF SECURITY INTEREST

PATENTS

THIS GRANT OF SECURITY INTEREST, dated as of October 10, 2000, is

executed by Procom Technology, Inc., a California corporation ("Borrower"), in favor of The

CIT Group/Business Credit, Inc. ("Lender").

A. Pursuant to a Financing Agreement dated as of the date hereof (the

"Financing Agreement") between Borrower and Lender, Lender has agreed to extend certain

credit facilities to Borrower upon the terms and subject to the conditions set forth therein.

B. Borrower owns the letters patent, and/or applications for letters patent, of

the United States, more particularly described on Schedules 1-A annexed hereto as part hereof

(collectively, the "Patents");

C. Borrower has entered into a Security Agreement (Intellectual Property)

dated the date hereof (the "Security Agreement") in favor of Lender; and

D. Pursuant to the Security Agreement, Borrower has granted to Lender a

security interest in all right, title and interest of Borrower in and to the Patents, together with any

reissue, continuation, continuation-in-part or extension thereof, and all proceeds thereof,

including any and all causes of action which may exist by reason of infringement thereof for the

full term of the Patents (the "Collateral"), to secure the prompt payment, performance and

observance of the Obligations, as defined in the Security Agreement;

1

NOW, THEREFORE, for good and valuable consideration, receipt of which is

hereby acknowledged, Borrower does hereby further grant to Lender a security interest in the

Collateral to secure the prompt payment, performance and observance of the Obligations.

Borrower does hereby further acknowledge and affirm that the rights and

remedies of Lender with respect to the security interest in the Collateral granted hereby are more

fully set forth in the Security Agreement, the terms and provisions of which are hereby

incorporated herein by reference as if fully set forth herein.

Lender's address is:

The CIT Group/Business Credit, Inc.

300 South Grand Ave.

Third Floor

Los Angeles, California 90071

Attn.: Manager

Telecopier No.: (213) 613-2501

IN WITNESS WHEREOF, Borrower has caused this Assignment to be executed

as of the day and year first above written.

PROCOM TECHNOLOGY, INC.

Name:

Title:

2

SCHEDULE 1-A TO GRANT OF SECURITY INTEREST

PATENTS

Title

Expansion slot adapter with embedded data device interface

Date Issued

December 31, 1991

Patent No.

5077683 *Procom
Technology, Inc. is assignee at issue

DOCSLA1:360950.1 6894-123-REB-10/9/00 6:21 PM

-1-

PATENT REEL: 011204 FRAME: 0707

CALIFORNIA ALL-PURPOSE ACKNOWLEDGMENT

STATE OF CALIFORNIA)) ss. COUNTY OF LOS ANGELES)											
On	On October 10, 2000, before me, Paul Toland, Notary Public Name and Title of Officer (e.g. "Jane Doe, Notary Public")										
per	personally appeared										
	personally known to me – OR – proved to me on the basis of satisfactory evidence to be the person(s) whose name(s) is/are subscribed to the within instrument and acknowledged to me that he/she/they executed the same in his/her/their authorized capacity(ies), and that by his/her/their signature(s) on the instrument the person(s), or the entity upon behalf of which the person(s) acted, executed the instrument. WITNESS my hand and official seal. Signature of Notary Public Signature of Notary Public										
OPTIONAL Though the data below is not required by law, it may prove valuable to persons relying on the document and could prevent fraudulent reattachment of this form.											
CAPACITY(IES) CLAIMED BY SIGNER(S) DESCRIPTION OF ATTACHED DO				DESCRIPTION OF ATTACHED DOCUMENT							
×	Individual Corporate Officer CFO			Grant of Security Interest (Patents)							
	Ti	tle(s)		Title or Type of Document							
	Partner(s)	☐ Limited ☐ General									
	Attorney-In-Fact Trustee(s) Guardian/Conservator Other:	- General		Number of Pages							
	***			Date of Document							
Signer is Representing: Name of Person(s) or Entity(ies)											
Procom Technology, Inc. Signer(s) Other Than Named Above											

DOCSLA1:354596.1 1-3205 PT2

RECORDED: 10/18/2000

PATENT REEL: 011204 FRAME: 0708